

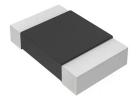
Current Sensing Resistors LMN25 Series



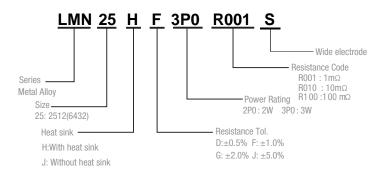


Description

- Proprietary processing technique produces extremely low resistance values
- Very low inductance
- Low thermal EMF
- Metallic Material



Part Numbering System



Standard
1~100mΩ : 2~3W
1~100mΩ
-55 to +170°C
± 50 ppm/°C
(P x R) ^{1/2}
(P / R) ^{1/2}

P=Power Rating; R=Resistance Value

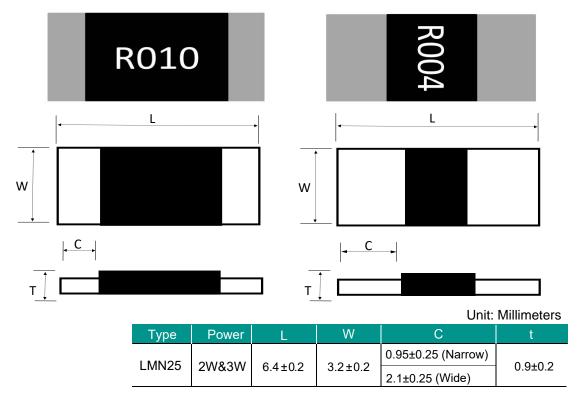
Standard Electrical Specifications

Туре	Rating Power at 70°C	T.C.R. (ppm/°C)	Resistance Range(m Ω) $\pm 0.5\%$ (D) $\pm 1.0\%$ (F) $\pm 2.0\%$ (G) $\pm 5.0\%$ (J)	Meterial	Electrode	Operating Temperature(°C)						
LMN25 I	LMN25J 2W LMN25H 2W&3W		5J 2W 50	2///	2///		2W 1-4		1-4		R001-R004:Wide	
LIVIIV233				50	2-10	CuMn	R002-R100:Narrow	-55~+170°C				
LMN25H			1-4		R001-R004:Wide							
			2-100		R002-R100:Narrow							

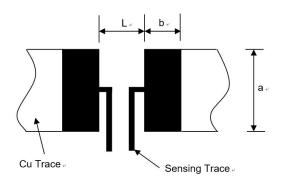


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Construction

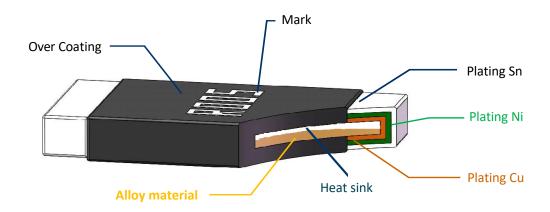


Recommended land pattern



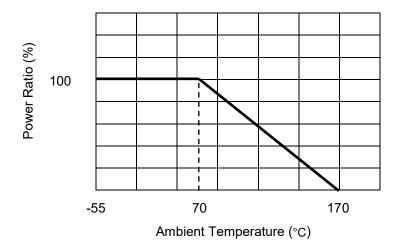
Unit: Millimeters							
Resistance Range (Ω)	а	b	L				
0.001-0.004(Wide)	4.0±0.1	3.1±0.1	1.3±0.1				
0.002~0.100(Narrow)	4.0±0.1	2.1±0.1	4.1±0.1				

Product structure diagram

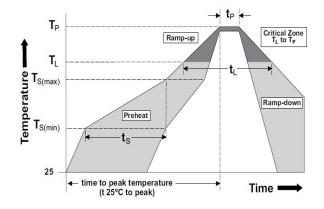


Power Derating Curve

For resistors operated in ambient temperatures 70°C, power rating shall be derated inaccording with the curve below:



Recommended Solder Curve



Reflow Cond	lition	Pb – Free assembly
	- Temperature Min (Ts(min))	150°C
Pre heat	- Temperature Max (Ts(max))	200°C
	- Time (Min to Max) (ts)	60 – 120 secs
	Average ramp up rate uidus Temp (TL) to peak	5°C/second max
TS(ı	max) to TL - Ramp-up Rate	5°C/second max
Reflow	- Temperature (TL) (Liquidus)	217°C
	- Time(tL)	60 – 150 seconds
	Peak Temperature (TP)	260°C
Time within 5	°C of actual peak Temperature (tp)	20 – 40 seconds
	Ramp-down Rate	5°C/second max
Time 2	5°C to peak Temperature (TP)	8 minutes Max.
	Wave Soldering	260°C, 10 seconds max.
	Hand Soldering	350°C, 5 seconds max.



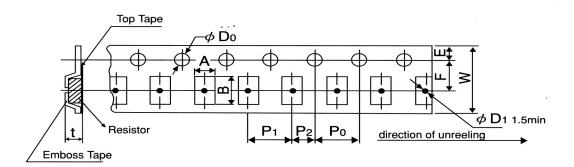
Product Characteristics

Item	Test condition/ Methods	Limited	Standard
Resistance	Measuring resistance value at room temperature 25℃±5℃	Refer to Spec	IEC60115-1 4.5
Temperature coefficient of resistance	TCR =(R-R ₀)/R ₀ (T2-T1)X 10 ⁶ T1 T2 R ₀ : resistance of room temperature R: resistance of 125 $^{\circ}$ C T1: Room temperature T2: Temperature at 125 $^{\circ}$ C	Refer to Spec	MIL-STD-202 Method 304
Short time Overload	Apply overload for 5 seconds and measure the resistance change rate after standing for 24 hours. 5 times the rated power for 5 seconds	≤±0.5%	MIL-R-26E
Resistance to Soldering Heat	Resistance to		MIL-STD-202 Method 210
Temperature Cycling	Temperature Cycling -55℃ (30min)/+125℃(30min), 1000 cycles		MIL-STD-202 Method107G
Low temperature Storage	I-55°C for 1000hours. No power		MIL-STD-26E
High Temperature Storage	125°C for 1000hours, No power	≤±1%	IEC6011501-4.25
Bias Humidity	Bias Humidity +85℃,85% RH,10%bias, 1000hours		MIL-STD-202 Method103
Joint Strength of Solder	Soldered on the bending test plate, put on the bending testing machine, pressed under force in the center of the test plate, measure its resistance variance rate under load	≤±0.5%	JIS-C5201
Solderability	Solderability 245±5℃, 2±0.5sec		IEC60115-1-4.17 JIS-C5201-4.17
Operational life 70°C± 2°C, 1000 hours, at rated power 1.5 hours "ON", 0.5 hours "OFF"		≤±1%	MIL-STD-202 Method 108



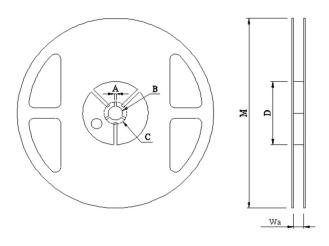
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Tapping & Package



Туре	Pack	A ±0.2	B ±0.2	D0 +0.5-0	E ±0.1	F ±0.05	P0 ±0.1	P1 ±0.1	P2 ±0.1	W ±0.2	D1 ±0.05	T ±0.15
2512	Emboss	3.60	6.90	1.50	1.75	5.50	4.00	4.00	2.00	12.00	1.50	1.20

Reel Specification



Туре	A	В	С	D	М	w
2512	2.00±0.5	13.50±0.5	21.00±0.5	80.00±1.0	178.00±2.0	13.80±0.5

Packaging

Quantity: 4, 000pcs

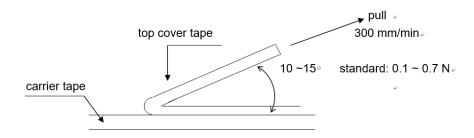
8mm wide tape on 178mm(7 inch) diameter reel -specification EIA

Standard 481.



Peel strength of upper belt

Stripping speed: 300 mm / min; The peel force is between 0.1N and 0.7n.



Storage conditions & shelf life

It can be stored for 2 years under closed conditions with temperature of 5 $^{\circ}$ C \sim 35 $^{\circ}$ C and relative humidity of 40 \sim 75

Please avoid the following harsh environment during storage to avoid affecting the product performance and solder connectivity: the places with corrosive gases such as sea breeze, Cl2, H2S, NH3, SO2 and NO2 shall be stored without direct sunlight.

Precautions for product use

When measuring the resistance value before welding, a special resistance meter with high precision shall be used. When measuring, a 4-wire probe or fixture must be used. 4. When measuring parts with a wire measuring needle, the 4 measuring needles must indeed contact the parts.

Avoid damaging the protective layer during manual welding or clamping with tweezers.

When the PCB is divided or fixed on the support, be careful to avoid excessive bending causing mechanical stress to the resistor.

It shall be used within the rated power range within the specification, especially when the power exceeds the rated value, which may affect the reliability of the product